



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Gap Filler 3500S35 (Two-Part)

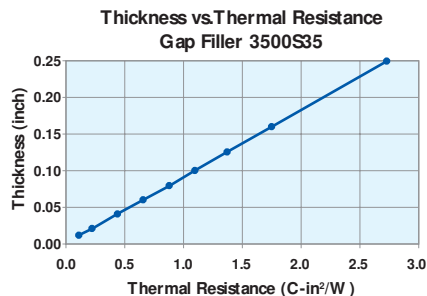
Thermally Conductive Liquid Gap Filling Material

Features and Benefits

- Thermal Conductivity: 3.6 W / m-K
- Thixotropic nature makes it easy to dispense
- Two-part formulation for easy storage
- Ultra-conforming - designed for fragile and low stress applications
- Ambient or accelerated cure schedules



Gap Filler 3500S35 is the technology leader in thermally conductive, liquid gap filling materials, featuring ultra-high thermal performance and superior softness. The material is two-component, cured either at room or elevated temperature. Prior to curing, the material maintains good thixotropic characteristics as well as low viscosity. The result is a gel-like liquid material designed to fill air gaps and voids yet flow when acted upon by an external force (e.g. dispensing or assembly process). The material is an excellent solution for interfacing fragile components with high topography and/or stack-up tolerances to a universal heat sink or housing. Once cured, it remains a low modulus elastomer designed to assist in relieving CTE stresses during thermal cycling yet maintain enough modulus to prevent pump-out from the interface. Gap Filler 3500S35 will lightly adhere to surfaces, thus improving surface area contact. Gap Filler 3500S35 is not designed to be a structural adhesive.



TYPICAL PROPERTIES OF GAP FILLER 3500S35			
PROPERTY	IMPERIAL VALUE	METRIC VALUE	TEST METHOD
Color / Part A	White	White	Visual
Color / Part B	Blue	Blue	Visual
Viscosity as Mixed (cps) (1)	150,000	150,000	ASTM D 2196
Density (g/cc)	3.0	3.0	ASTM D 792
Mix Ratio	1:1	1:1	—
Shelf Life @ 25°C (months)	5	5	—
PROPERTY AS CURED			
Color	Blue	Blue	Visual
Hardness (Shore 00) (2)	35	35	ASTM D 2240
Continuous Use Temp (°F) / (°C)	-76 to 392	-60 to 200	—
ELECTRICAL AS CURED			
Dielectric Strength (V/mil)	275	275	ASTM D 149
Dielectric Constant (1000 Hz)	8.0	8.0	ASTM D 150
Volume Resistivity (Ohm-meter)	10 ⁹	10 ⁹	ASTM D 257
Flame Rating	V-0	V-0	U.L. 94
THERMAL AS CURED			
Thermal Conductivity (W / m-K)	3.6	3.6	ASTM D 5470
CURE SCHEDULE			
Pot Life @ 25°C (min) (3)	60	60	—
Cure @ 25°C (hrs) (4)	15	15	—
Cure @ 100°C (min) (4)	30	30	—

1) Brookfield RV, Hell-Path, Spindle TF @ 20 rpm, 25°C.
 2) Thirty second delay value Shore 00 hardness scale.
 3) Time for viscosity to double.
 4) Cure schedule (rheometer - time to read 90% cure)

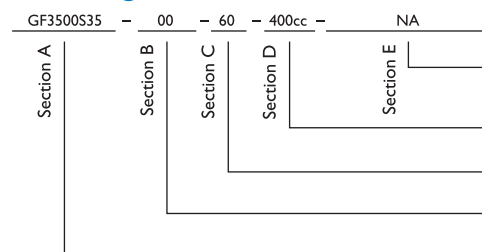
Typical Applications Include:

- Automotive electronics
- Discrete components to housing
- PCBA to housing
- Fiber optic telecommunications equipment

Configurations Available:

- Supplied in cartridge or kit form

Building a Part Number



Note: To build a part number, visit our website at www.bergquistcompany.com.

Standard Options

◀ example

NA = Selected standard option. If not selecting a standard option, insert company name, drawing number, and revision level.

Cartridges: 50cc = 50.0cc, 400cc = 400.0cc
 Kits: 1200cc = 1200.0cc, or 6G = 6 gallon

Pot Life: 60 = 60 minutes

00 = No spacer beads
 07 = 0.007" spacer beads

GF3500S35 = Gap Filler 3500S35 Material

Gap Pad®: U.S. Patent 5,679,457 and others



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